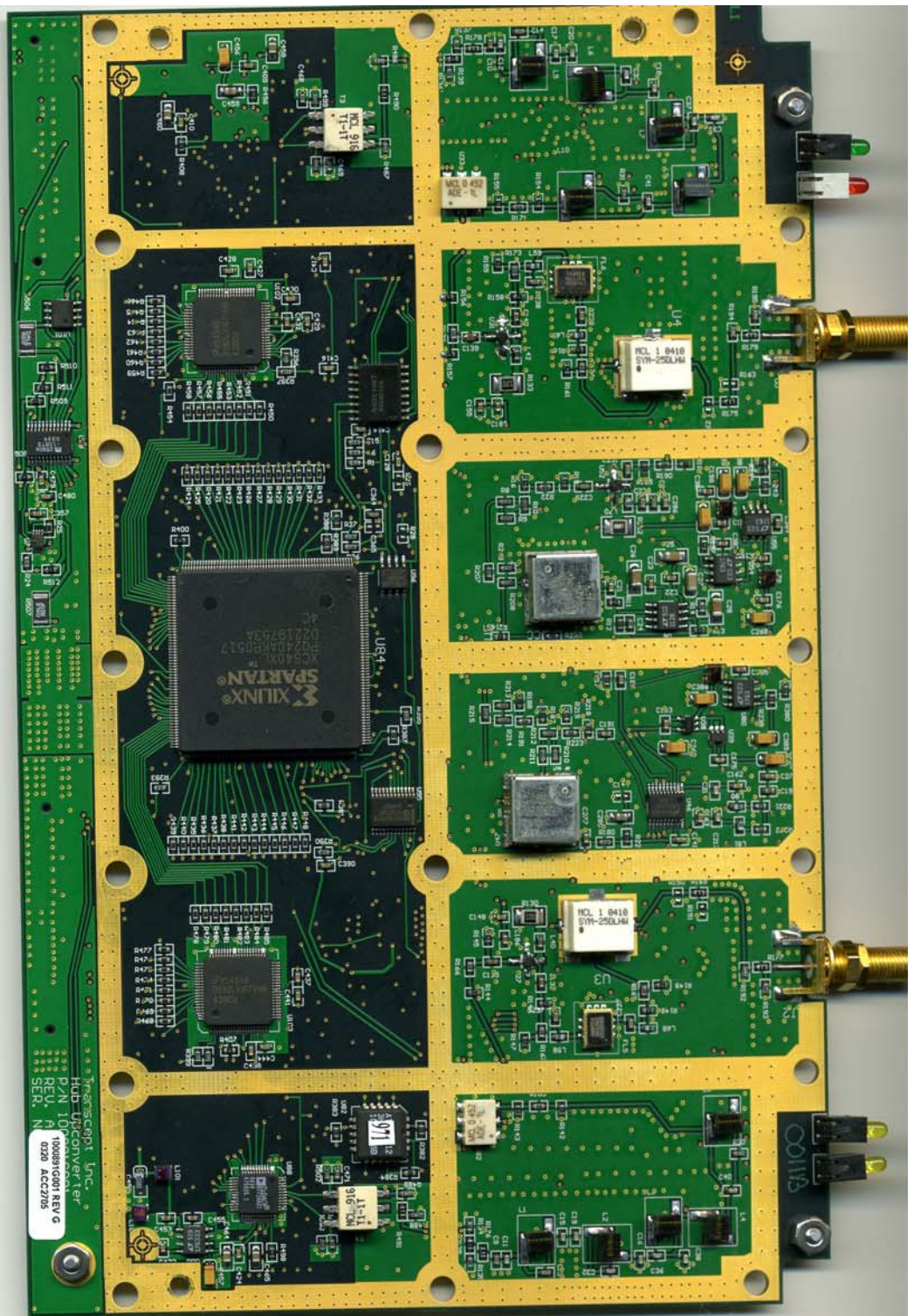
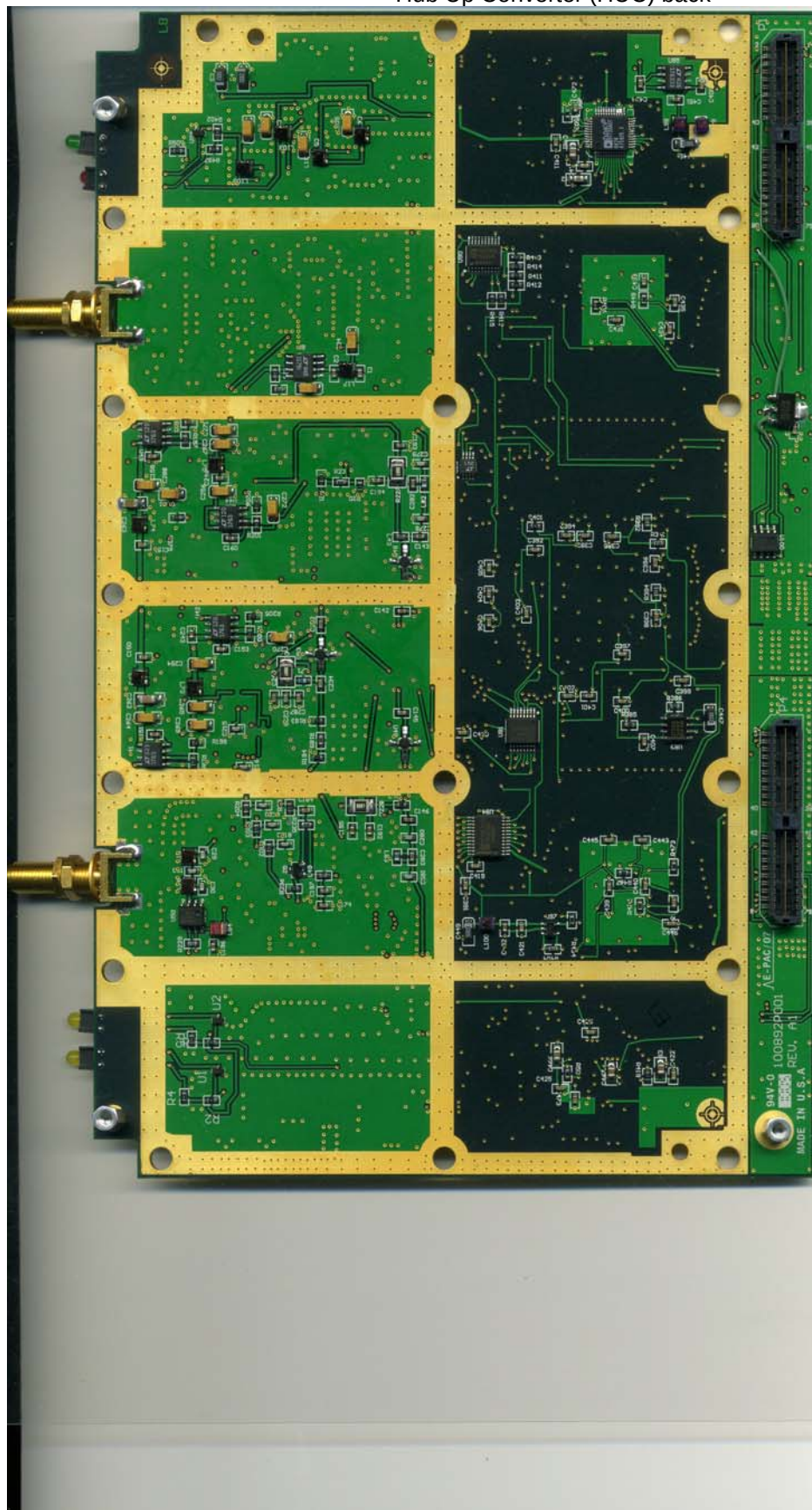


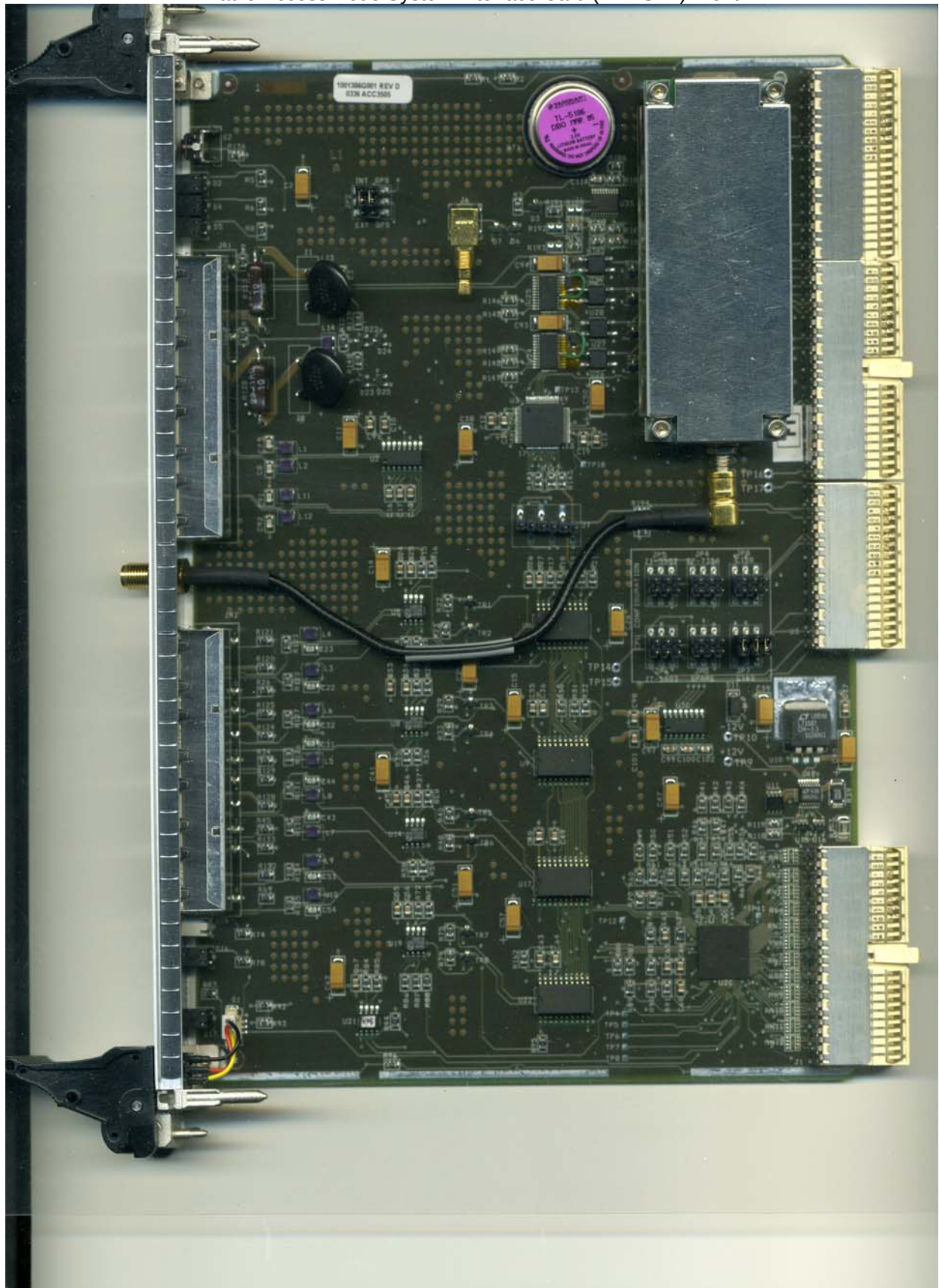
Hub Up Converter (HUC) Front



BAV-5 100892P001
AE-TAC-07
REV. A1
MADE IN U.S.A.

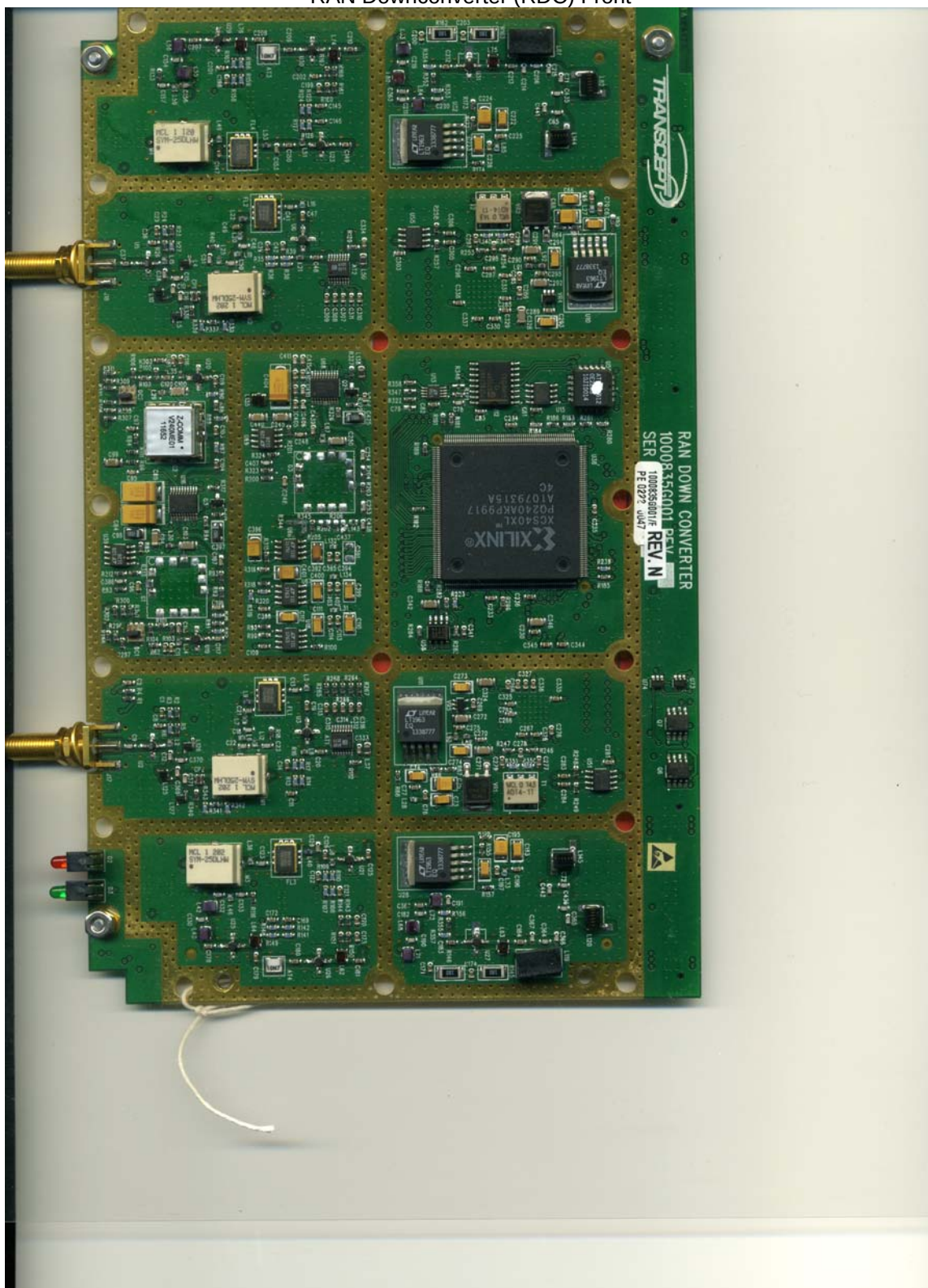


Radio Access Node System Interface Card (RANSTF) Front

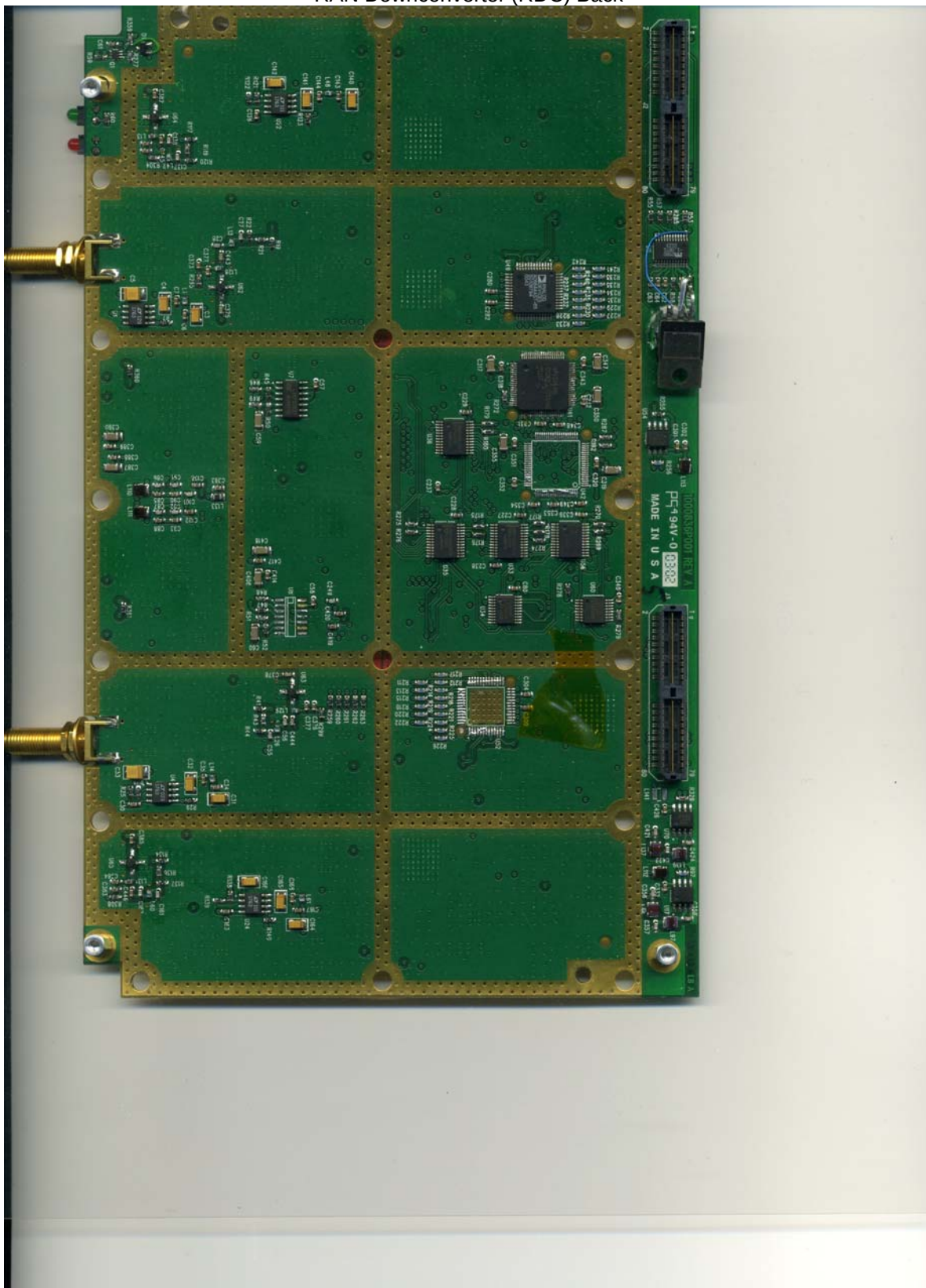


1001387P001 REV A1
MADE IN USA

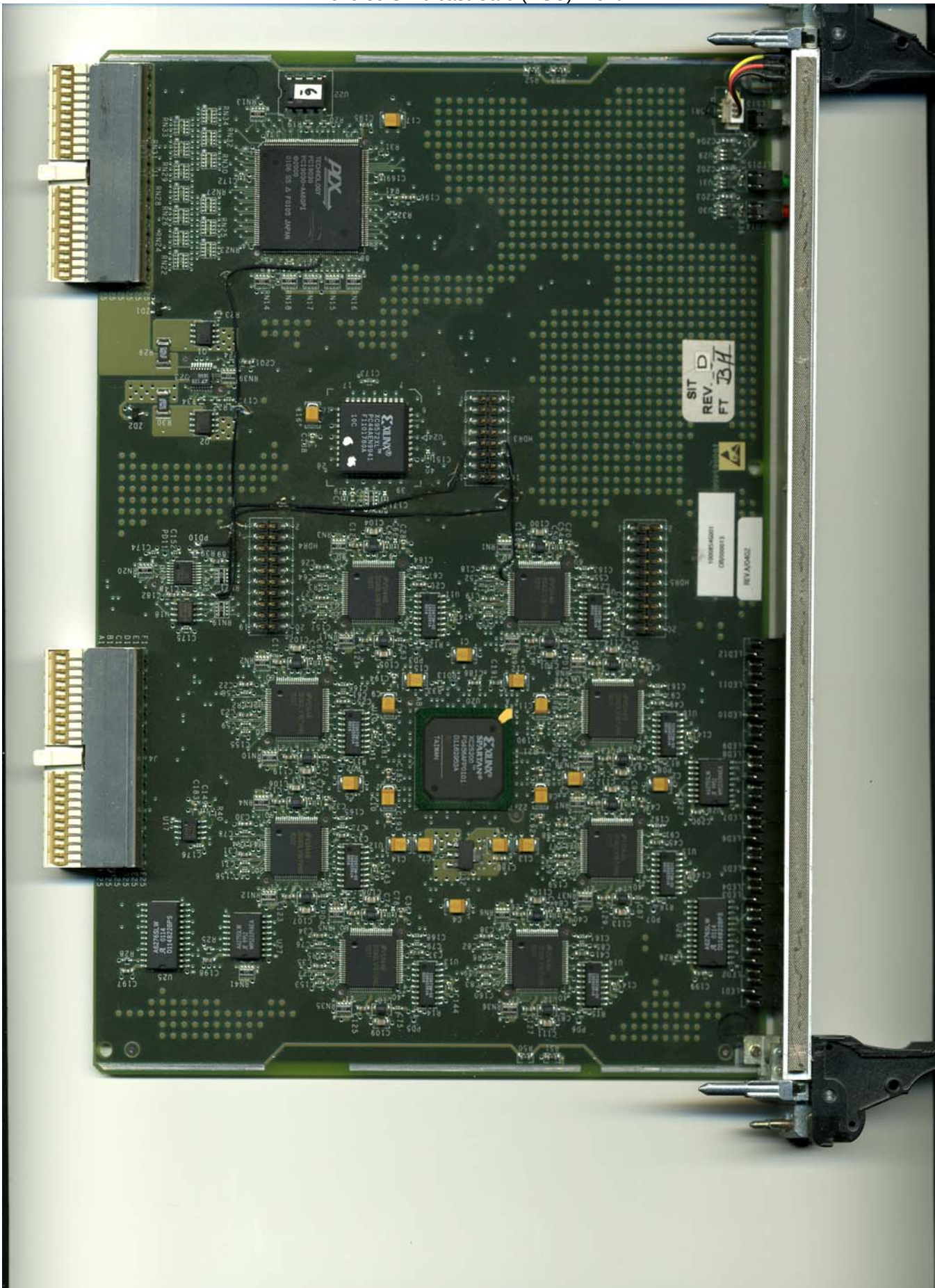
RAN Downconverter (RDC) Front



The image shows a green printed circuit board (PCB) for a radio receiver, identified by the label 'PC-94V-0 0302' and 'MADE IN U.S.A.'. The board is populated with various electronic components, including integrated circuits, capacitors, resistors, and connectors. It features two gold-plated SMA connectors on the left side and a multi-pin connector on the right. The board is divided into several functional blocks by white silkscreen lines. The components are labeled with part numbers and values, such as 'C101 100pF', 'R101 10k', and 'C102 100pF'. The board is mounted on a white surface.

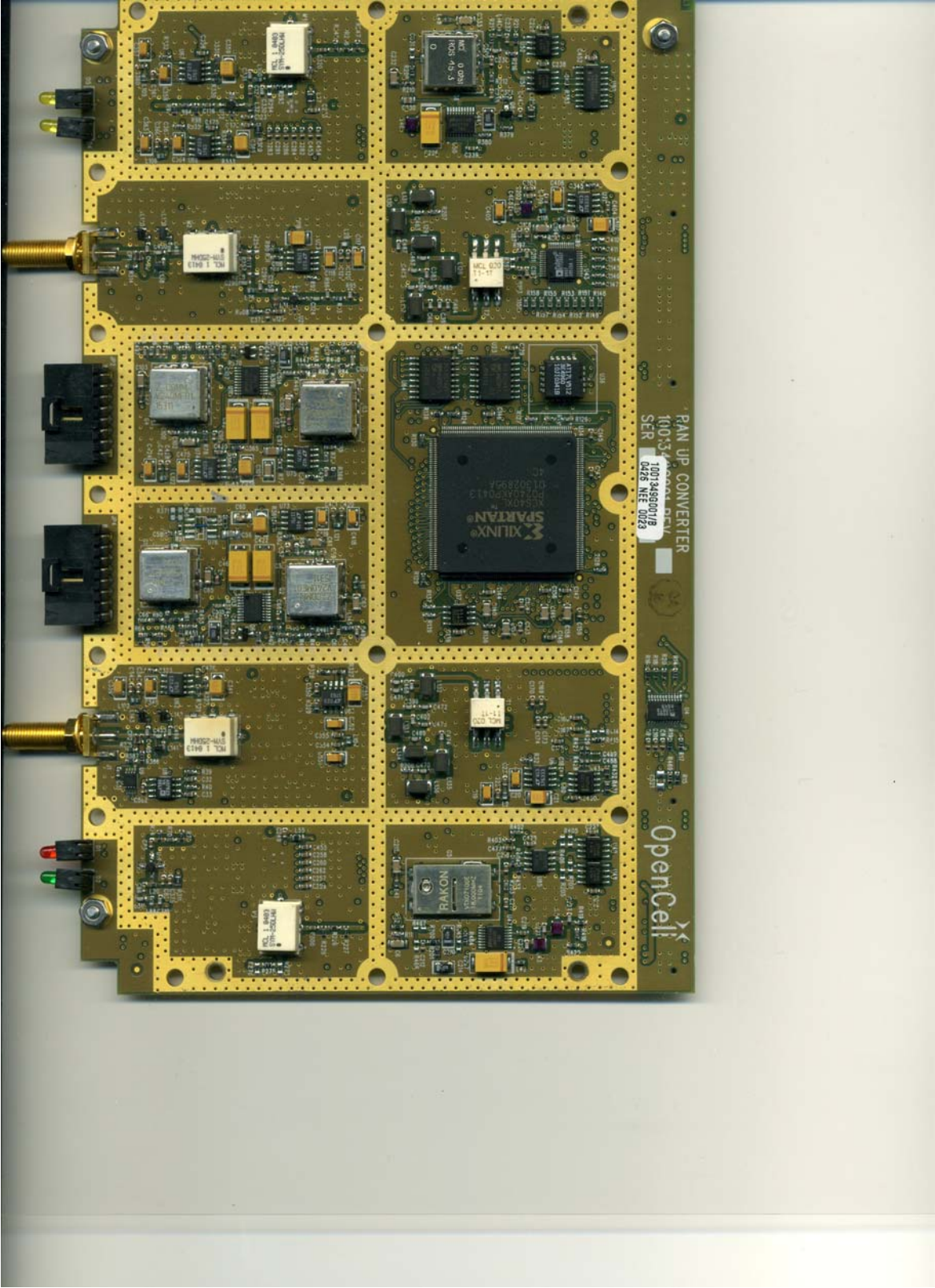


A detailed photograph of a laptop motherboard, showing various components like the CPU, RAM, and storage. The motherboard is green and populated with numerous integrated circuits, capacitors, and connectors. A white label with 'SIT D REV. 1.0 FT BH' is visible. The motherboard is shown from a top-down perspective, with the edges of the laptop chassis visible.

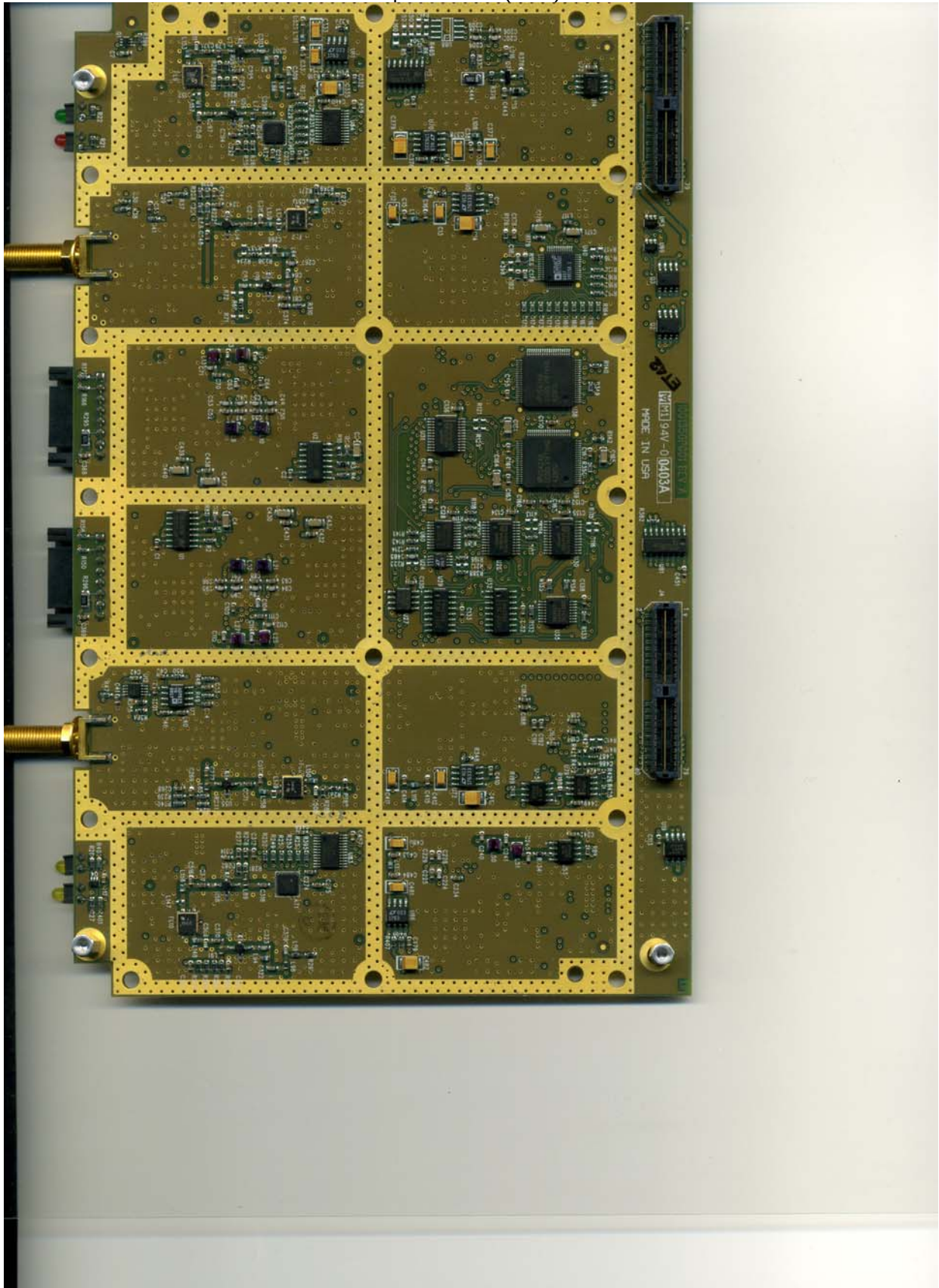


[illegible]

RAN Up Converter (RUC) Front

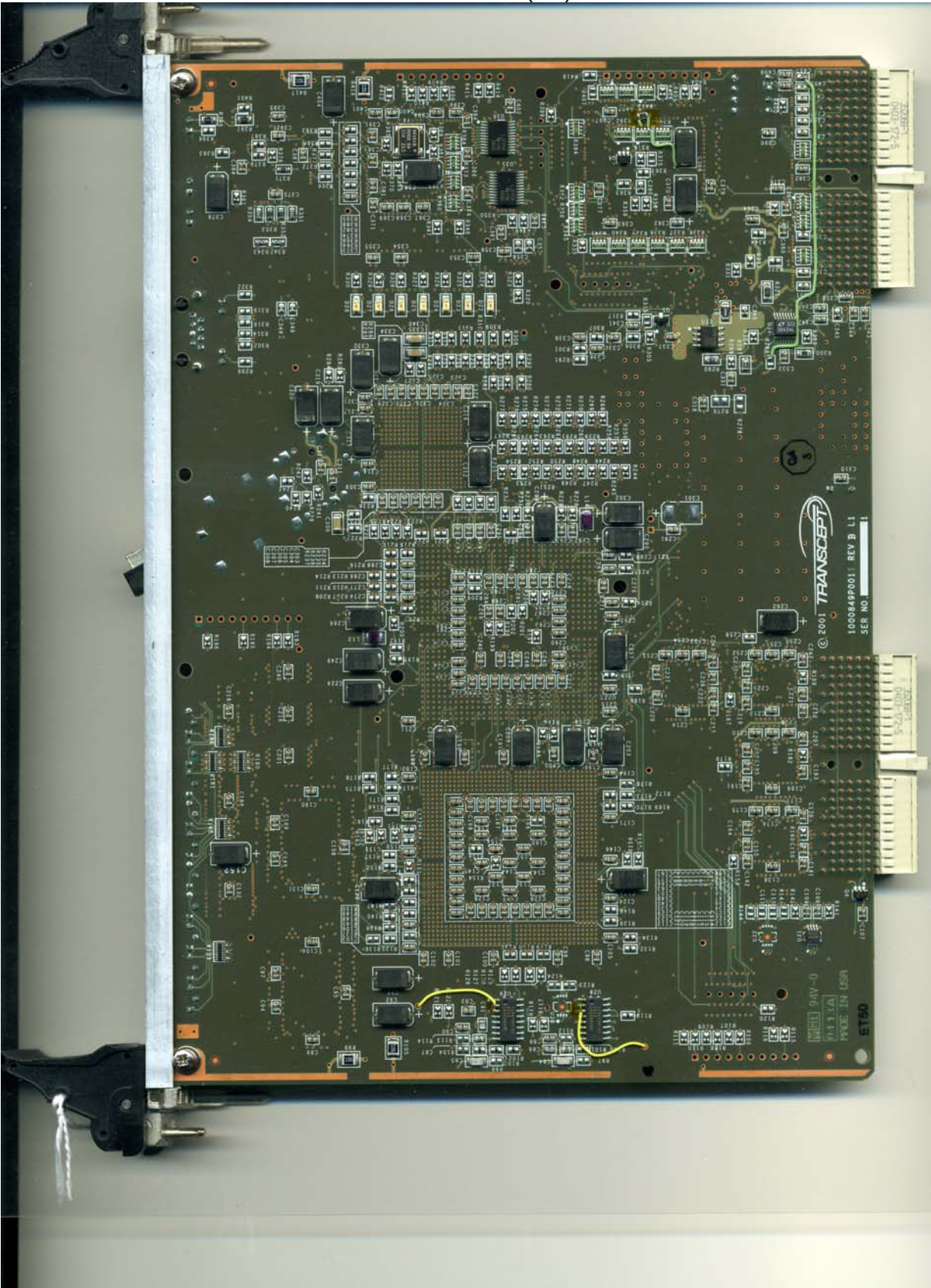


RAN Up Converter (RUC) Back

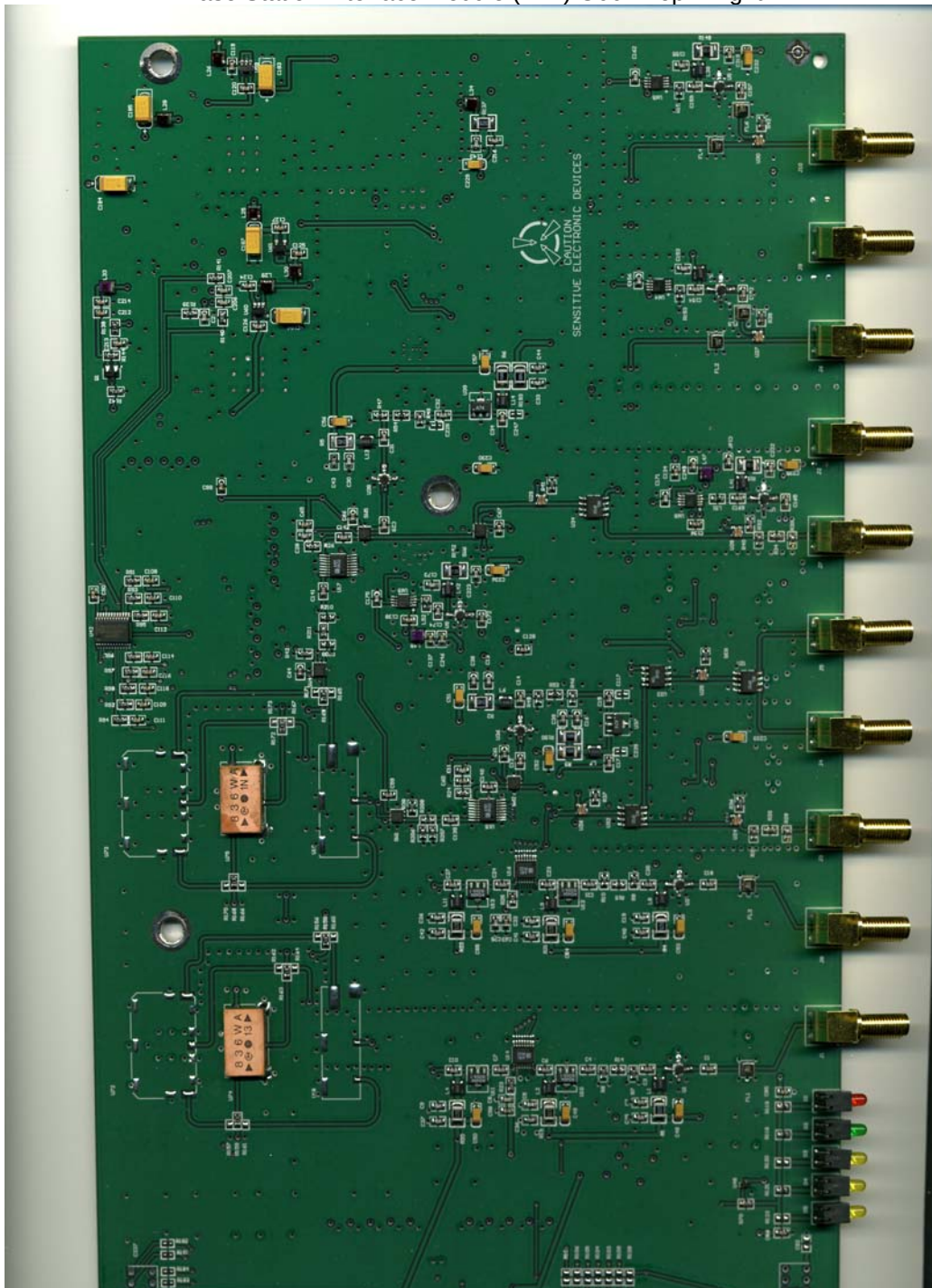


A detailed photograph of a laptop motherboard, showing various components like the CPU, RAM, and power management chips. The motherboard is populated with several integrated circuits, including a large Xilinx FPG/ASIC chip in the center, an AMD BIOS chip, and a Datel DC/DC converter. Numerous capacitors, resistors, and other passive components are visible across the board. The board is populated with various integrated circuits, including a large Xilinx FPG/ASIC chip in the center, an AMD BIOS chip, and a Datel DC/DC converter. Numerous capacitors, resistors, and other passive components are visible across the board. The board is populated with various integrated circuits, including a large Xilinx FPG/ASIC chip in the center, an AMD BIOS chip, and a Datel DC/DC converter. Numerous capacitors, resistors, and other passive components are visible across the board.

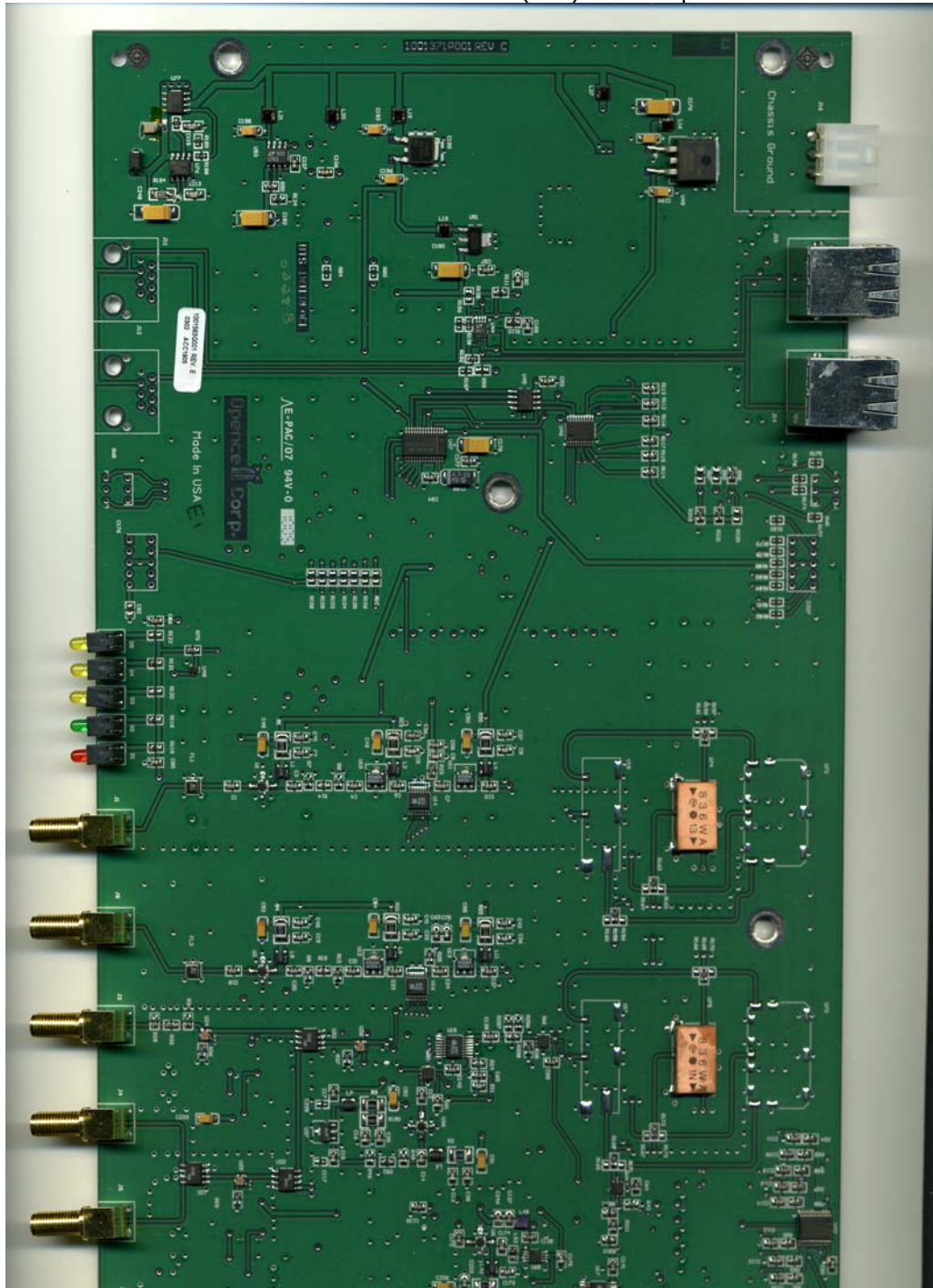
Sonet Interface Module (SIF) Back



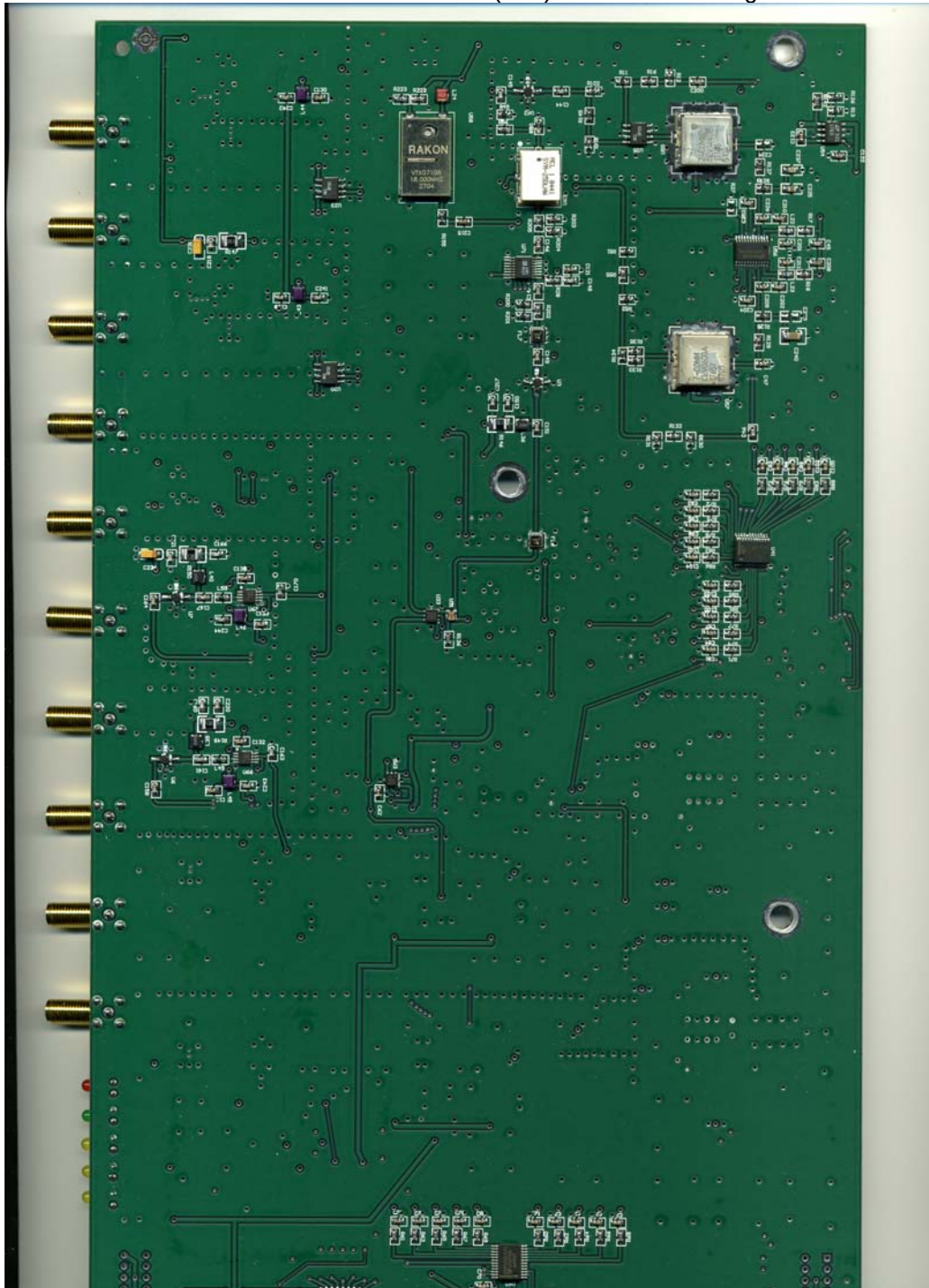
Base Station Interface Module (BIM) G001 Top - Right



Base Station Interface Module (BIM) G001 Top - Left



Base Station Interface Module (BIM) G001 Bottom - Right



Base Station Interface Module (BIM) G001 Bottom - Left

